

**DAP Scholarship Application Form
2023 Winter Session (post-term)
Application Deadline - April 30, 2024**

5008 CPABC Bill Johnson DAP Student Achievement Award - 1 x \$2100

PLEASE COMPLETE ALL SECTIONS

The following documents must be submitted to the DAP office prior to the application deadline:

- DAP Award Application Form - with all sections completed
- Up-to-date resume (2 pages maximum)
- 2 reference letters from professional contacts, written on the organization's letterhead) references from academic contacts and personal character references will not be accepted)

Open to DAP students enrolled in 2023 Winter Session courses, who have completed a minimum of 9 DAP credit units, including BUSI 353 and BUSI 450, with a minimum overall average of 75% by end of the 2023 Winter Session (April 30, 2024).

A - PERSONAL DATA

Last/Family Name

First/Given Name

Middle Name

Street Address

City

Province/State

Country

Postal/Zip Code

Telephone (please include area code)

Alternate Telephone

Email

Date of Birth (yy/mm/dd)

Student Number

B - Scholarships & Awards

Please select from the list below which award(s) you are applying for:

5008 CPABC Bill Johnson DAP Student Achievement Award (1 x \$2100 available)

C - Community Involvement

Please provide a brief paragraph outlining your volunteer involvement in the community. Examples may be drawn from on campus and/or off campus contexts. If more space is required, please include an additional page (maximum 1 page) clearly identifying Section C - Community Involvement. Please identify depth (hours per week) and duration of each involvement.

D - Leadership

Please provide a brief paragraph outlining ways and activities to which you have exhibited leadership. Examples may be drawn from family, social, employment and/or educational contexts. If more space is required, please include an additional page (maximum 1 page) clearly identifying Section D - Leadership. Please identify depth (hours per week) and duration of each activity.

E - DECLARATION

I confirm that the information provided in this application is true and portrays an accurate description of my community involvement and leadership abilities. I do acknowledge that if any or all information provided in this application is untrue, the applications review committee will disregard all documents submitted for scholarships & awards.

Signature of Applicant

Date

PLEASE REVIEW THE CHECKLIST BELOW BEFORE SUBMITTING YOUR APPLICATION

Personal information provided on this application form is collected pursuant to the *University Act*, RSBC 1996, c.468, and the *Freedom of Information and Protection of Privacy Act*, RSBC 1996, c.165. The information will be used for the purposes of scholarship & award administration. Information may also be provided to university student and alumni bodies, to other educational institutions, to the professional organizations in British Columbia and may be used for research purposes. When used for research purposes individual identities will not be disclosed. Information may also be used for compiling aggregated statistics. For further information, please contact the Diploma in Accounting Program, Sauder School of Business, The University of British Columbia.

DAP SCHOLARSHIPS & AWARDS APPLICATION CHECKLIST

DAP Scholarships & Awards Application Form (4 pages)

Up-to-date resume (1-2 pages)

2 reference letters from professional contacts in support of your community and/or leadership experience (may also be sent directly to the DAP office by your referee); personal character references from relatives or friends are not accepted

Application form must be signed

Maximum page limit for submission (7 to 10 pages in total)

Ready to submit?

- Prepare and gather all of the required components for the application and submit all as individual attachments by e-mail to dap@sauder.ubc.ca.

The review process will be completed in May. Once a decision has been made by the Award Committee, all applicants will be notified by mail.

Please email dap@sauder.ubc.ca if your mailing address changes after submitting your application form or if you have any questions regarding your submission.